OMB No. 0651-0027 (exp. 6/30/2008) United States Patent and Trademark O RECORDATION FORM COVER SHEET	
PATENTS ONLY To the Director of the U.S. Patent and Trademark Office: Please record the attached documents or the new address(es) below.	
Hyun Yul Kwon	Name: HYNIX SEMICONDUCTOR INC.
Additional name(s) of conveying party(ies) attached?	Street Address:
3. Nature of conveyance/Execution Date(s):	
Execution Date: December 17, 2001	San 136-1, Ami-ri, Bubal-eub
X Assignment Merger Change of Name	
Security Agreement Joint Research Agreement	City: Icheon-si
Government Interest Assignment	State: Kyoungki-do
Executive Order 9424, Confirmatory License	Country: Republic of Korea Zip: 467-701
	Additional name(s) & address(es) Yes X No
	attached?
4. Application or patent number(s):	This document is being filed together with a new application.
A. Patent Application No.	B. Patent No.(s)
11/964,350	
Additional numbers attached?	
 Name and address to whom correspondence concerning document should be mailed: 	6. Total number of applications and patents involved:
Name: Anthony G. Sitko	
MARSHALL, GERSTEIN & BORUN LLP	7. Total fee (37 CFR 1.21(h) & 3.41) \$ 40.00
Internal Address: Atty. Dkt.: 29936/43411	Authorized to be charged by credit card
Street Address: 233 S. Wacker Drive, Suite 6300	X Authorized to be charged to deposit account
Sears Tower	Enclosed
	None required (government interest not affecting title
	Some required (government interest not arredling title
City: Chicago	8. Payment Information
State: IL Zip: 60606-6357	a. Credit Card Last 4 Numbers
Phone Number: (312) 474-6300 Fax Number: (312) 474-0448	Expiration Date
Fax Number: (312) 474-0448 Email Address: asitko@marshallip.com	b. Deposit Account Number 13-2855 Authorized User Name Anthony G. Sitko
Signature	
). Signature:	
CCS	December 28, 2007
Signature	Date
CCS	
Anthony G. Sitko - 36,278 Name of Person Signing	Date Total number of pages including cover sheet, attachments, and documents:
Anthony G. Sitko - 36,278	Date Total number of pages including cover sheet, attachments, and documents: tached or grolosed) is being transmitted by facsimile to the Patent and

PATENT REEL: 020312 FRAME: 0061

ASSIGNMENT

Serial No: 11/964,350 Filed: December 26, 2007

Title: SEMICONDUCTOR DEVICE AND METHOD OF FABRICATING THE SAME

For good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, the undersigned hereby assign to **HYNIX SEMICONDUCTOR INC.**, San 136-1, Ami-ri, Bubal-eub, Icheon-si, Kyoungki-do, REPUBLIC OF KOREA (hereinafter "Assignee"), its successors and assigns, the entire right, title and interest in the invention or improvements of the undersigned disclosed in an application for letters patent of the United States, executed by the undersigned on, <u>December 17, 2007</u> and in said application and any and all other applications, both in the United States and in other countries, which the undersigned may file or be named as an inventor, either solely or jointly with others, on said invention or improvements, and in any and all letters patent of the United States and other countries, which may be obtained on any of said applications, and in any reissue or extension thereof.

The undersigned hereby authorize and request the Commissioner for Patents to issue said letters patent to said Assignee.

The undersigned hereby authorize and request that the attorneys of record in said application insert in this assignment the execution date and/or filing date and serial number of said application when officially known.

The undersigned warrant themselves to be the owners of the interest herein assigned and to have the right to make this assignment and further warrant that there are no outstanding prior assignments, licenses, or other rights in the interest herein assigned except in favor of Assignee.

For said consideration the undersigned hereby agree, upon the request and at the expense of said Assignee, its successors and assigns, to execute any and all applications on said invention or improvements, and any necessary oath or affidavit relating thereto, and any application for the reissue or extension of any letters patent that may be granted upon any and all of said applications, and any and all applications and other documents for letters patent in other countries on said invention or improvements, that said Assignee, its successors or assigns, may deem necessary or expedient, and for said consideration the undersigned further agree upon the request of said Assignee, its successors or assigns, in the event of any application or letters patent assigned herein becoming involved in Interference or Opposition, to cooperate to the best of the ability of the undersigned with said Assignee, its successors or assigns, in the matters of preparing and executing the preliminary statement and giving and producing evidence in support thereof, the undersigned hereby agreeing to perform, upon request, any and all affirmative acts to obtain said letters patent, both in the United States and in other countries, and vest all rights therein hereby conveyed in said Assignee, its successors and assigns, whereby said letters patent will be held and enjoyed by said Assignee, its successors and assigns, to the full end of the term for which said letters patent may be granted as fully and entirely as the same would have been held and enjoyed by the undersigned if this assignment and sale had not been made.

PATENT REEL: 020312 FRAME: 0062

Hyun Yul Ku Name: Hyun Yul KWON Pecember 19,200 ON 1) Date 2)

Name:

Date

